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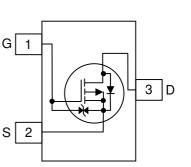
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January 2006

FDY101PZ Single P-Channel (- 2.5V) Specified PowerTrench[®] MOSFET **General Description** Features This Single P-Channel MOSFET has been designed using Fairchild Semiconductor's advanced Power Trench process to optimize the $R_{DS(ON)} @V_{GS} = -2.5v$. • $-150 \text{ mA}, -20 \text{ V} \text{ R}_{\text{DS(ON)}} = 8 \Omega \text{ @ } \text{V}_{\text{GS}} = -4.5 \text{ V}$ **Applications** • ESD protection diode (note 3) Li-Ion Battery Pack RoHS Compliant S G D

FAIRCHILD SEMICONDUCTOR



 $R_{DS(ON)} = 12 \Omega @ V_{GS} = -2.5 V$

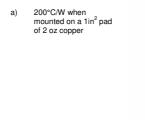
Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DSS}	Drain-Source Voltage			- 20	V
V _{GSS}	Gate-Source Voltage			± 8	V
I _D	Drain Current	– Continuous	(Note 1a)	- 150	mA
		– Pulsed		- 1000	
PD	Power Dissip	ation (Steady State)	(Note 1a)	625	mW
			(Note 1b)	446	
- -	Operating and Storage Junction Temperature			-55 to +150	°C
IJ, ISTG	Range	a Storage sufficient rel	mperature		Ũ
TJ, TSTG Therma	_ · · · ·				
Therma	Range		·	200	°C/W
Therma	Range I Charact Thermal Resi	eristics	nbient (Note 1a)		
Therma R _{0JA} R _{0JA}	Range I Charact Thermal Resi Thermal Resi	eristics stance, Junction-to-Ar	nbient (Note 1a)	200	
Therma R _{eja} Reja Packag	Range I Charact Thermal Resi Thermal Resi	eristics stance, Junction-to-Ar stance, Junction-to-Ar	nbient (Note 1a)	200	

Parameter	Test Conditions	Min	Тур	Max	Units
acteristics			•		
Drain–Source Breakdown Voltage	$V_{GS}=0~V, \qquad I_{D}=-250~\mu A$	- 20			V
Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu A$, Referenced to $25^{\circ}C$		15		mV/°C
Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			- 3	μA
Gate-Body Leakage,	$V_{GS} = \pm 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			± 10	μA
acteristics (Note 2)					
Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.65	- 1.0	- 1.5	V
Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-3		mV/°C
Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS}=-4.5 \ V, \ I_{D}=-150 \ mA \\ V_{GS}=-2.5 \ V, \ I_{D}=-125 \ mA \\ V_{GS}=-1.8 \ V, \ I_{D}=-100 \ mA \\ V_{GS}=-1.5 \ V, \ I_{D}=-30 \ mA \\ V_{GS}=-4.5 \ V, \ I_{D}=-150 \ mA, \\ T_{1}=125^{\circ} C \end{array} $			8 12 15 20 12	Ω
Forward Transconductance	$V_{DS} = -5 V$, $I_D = -150 mA$		0.7		S
Characteristics					
1		İ	100		pF
					pF
· · ·					pr pF
· · ·			15		рі
				10	
					ns
	$V_{\rm GS} = -4.5$ V, $T_{\rm GEN} = 0.52$				ns
					ns
					ns
Total Gate Charge			1.0	1.4	nC
Gate-Source Charge	$V_{GS} = -4.5 V$		0.2		nC
Gate-Drain Charge			0.3		nC
ource Diode Characteristics	and Maximum Ratings				
Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_{S} = -150 \text{ mA}(\text{Note 2})$		- 0.8	- 1.2	V
	I _F = − 150 mA.		11		ns
Diode Reverse Recovery Time	dl _F /dt = 100 A/μs				
	Drain–Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate–Body Leakage, acteristics (Note 2) Gate Threshold Voltage Gate Threshold Voltage Temperature Coefficient Static Drain–Source On–Resistance On–Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance g Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Drain Charge	$\begin{tabular}{ c c c c } \hline $V_{GS} = 0 V, $I_D = -250 μA$ \\ \hline V_{Oltage} \\ \hline $Preakdown Voltage Temperature Coefficient$ \\ \hline $I_D = -250 μA$, Referenced to 25°C$ \\ \hline $Qate-Body Leakage, $V_{DS} = -16 V, $V_{GS} = 0 V \\ \hline $Qate-Body Leakage, $V_{GS} = \pm 8 V, $V_{DS} = 0 V \\ \hline $Qate-Body Leakage, $V_{GS} = \pm 8 V, $V_{DS} = 0 V \\ \hline $Qate-Body Leakage, $V_{DS} = V_{GS}, $I_D = -250 μA$ \\ \hline $Qate-Body Leakage, $V_{DS} = V_{GS}, $I_D = -250 μA$ \\ \hline $Qate-Body Leakage, $V_{DS} = V_{GS}, $I_D = -250 μA$ \\ \hline $Qate-Body Leakage, $V_{DS} = V_{GS}, $I_D = -250 μA$ \\ \hline $Qate-Body Leakage, $V_{DS} = V_{GS}, $I_D = -250 μA$ \\ \hline $Qate-Body Leakage, $V_{DS} = V_{GS}, $I_D = -250 μA$ \\ \hline $Qate-Body Leakage, $V_{DS} = -4.5 V, $I_D = -150 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -150 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -100 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -100 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -100 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -100 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -150 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -150 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -150 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -150 mA$ \\ \hline $V_{GS} = -1.8 V, $I_D = -150 mA$ \\ \hline $V_{GS} = -10 V, $V_{GS} = 0 V, $I_D = -150 mA$ \\ \hline $Porward Transconductance $V_{DS} = -10 V, $V_{GS} = 0 V, $I_D = -0.5 A, $V_{GS} = -4.5 V, $R_{GEN} = 6 Ω \\ \hline $Turn-On Blay Time $V_{DD} = -10 V, $I_D = -0.5 A, $V_{GS} = -4.5 V, $R_{GEN} = 6 Ω \\ \hline $Turn-Off Delay Time $V_{DS} = -10 V, $I_D = -150 mA$, $V_{GS} = -4.5 V, $R_{GEN} = 6 Ω \\ \hline $Turn-Off Fall Time $V_{DS} = -10 V, $I_D = -150 mA$, $V_{GS} = -4.5 V \\ \hline $Qate-Drain Charge $V_{DS} = -10 V, $I_D = -150 mA$, $V_{GS} = -4.5 V \\ \hline $Qate-Drain Charge $V_{DS} = -10 V, $I_D = -150 mA$, $V_{GS} = -4.5 V \\ \hline $Qate-Drain Charge $V_{DS} = -10 V, $I_D = -150 mA$, $V_{GS} = -4.5 V \\ \hline $Qate-Drain Charge $V_{DS} = -10 V, $I_D = -150 mA$, $V_{GS} = -4.5 V \\ \hline $Qate-Drain Charge $V_{DS} = -10 V, $I_D = -150 mA$, $V_{GS} = -4.5 V	$\begin{tabular}{ c c c c c } \hline Drain-Source Breakdown V_{GS} = 0 V, & I_D = -250 \ \mu\text{A} & -20 \\ \hline Voltage Breakdown Voltage Temperature I_{D} = -250 \ \mu\text{A}, Referenced to 25°C \\ \hline Zero Gate Voltage Drain Current V_{DS} = -16 V, V_{GS} = 0 V \\ \hline Gate-Body Leakage, & V_{GS} = \pm 8 V, V_{DS} = 0 V \\ \hline Gate-Body Leakage, & V_{GS} = \pm 8 V, V_{DS} = 0 V \\ \hline acteristics (Note 2) \\ \hline Gate Threshold Voltage (Note 2) \\ \hline Static Drain-Source (On-Resistance (Note 2) + 150 \ mA \\ V_{GS} = -4.5 \ V, \ I_D = -150 \ mA \\ V_{GS} = -1.5 \ V, \ I_D = -150 \ mA \\ V_{GS} = -4.5 \ V, \ I_D = -150 \ mA \\ V_{GS} = -4.5 \ V, \ I_D = -150 \ mA \\ \hline V_{GS} = -4.5 \ V, \ I_D = -150 \ mA \\ \hline V_{GS} = -4.5 \ V, \ I_D = -150 \ mA \\ \hline Characteristics (Note 2) \\ \hline Input Capacitance (Note 2) \\ \hline Turn-On Delay Time (Note 2) \\ \hline Turn-On Rise Time (Note 2) \\ \hline Turn-On Rise Time (Note 2) \\ \hline Turn-Of Fall Time (Note 2) \\ \hline Turn-Off Colley Time (Note 2) \\ \hline Turn-Off Colley Time (Note 2) \\ \hline Turn-Off Fall Time (Note 2) \\ \hline Turn-Off Colley Time (Note 2) \\ \hline Turn-Off Fall Time (Note 2) \\ \hline Turn$	$\begin{tabular}{ c c c c c } \hline Drain-Source Breakdown Voltage Temperature Coefficient & I_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & 15 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & 15 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & 15 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -250 \ \mu\text{A}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -150 \ \text{MA}, Referenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -10 \ \text{MB}, Reterenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -10 \ \text{MB}, Reterenced to 25^{\circ}\text{C} & -3 \\ \hline D_D = -10 \ $	

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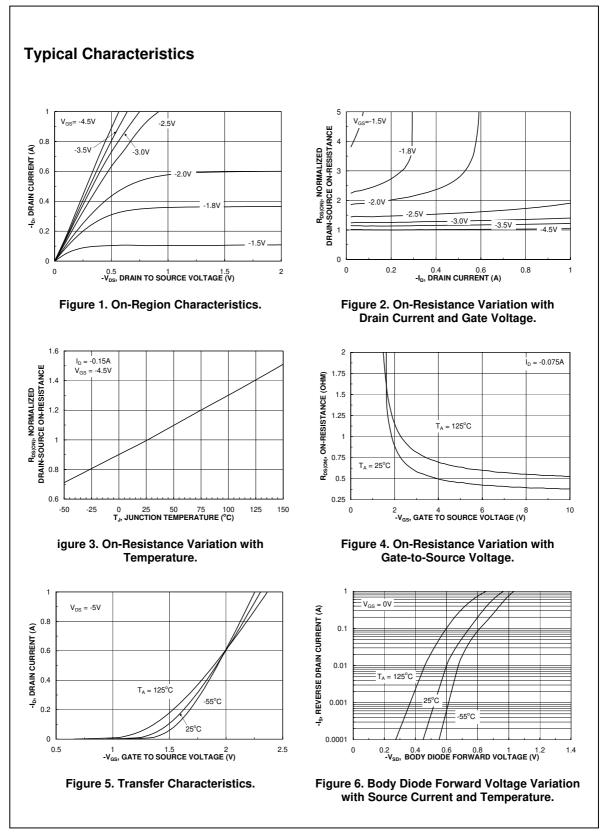


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2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

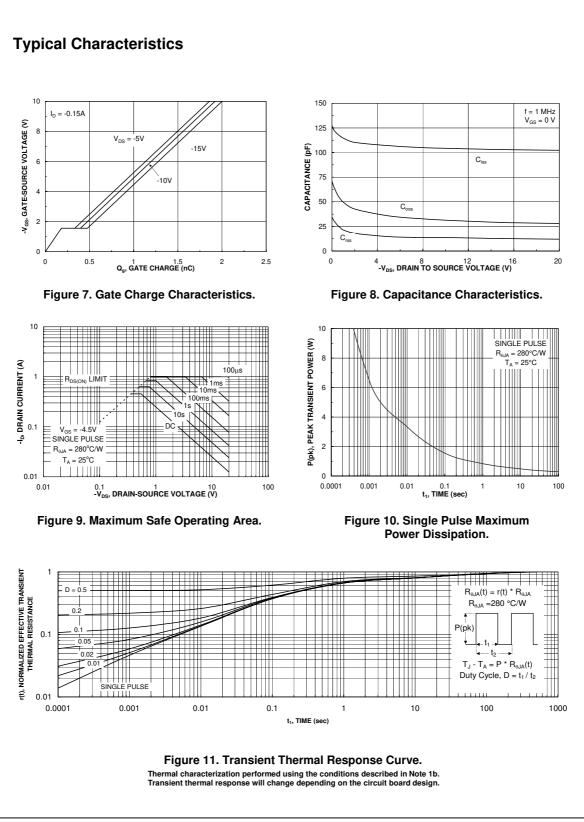
3. The diode connected between the gate and source serves only as protection againts ESD. No gate overvoltage rating is implied.

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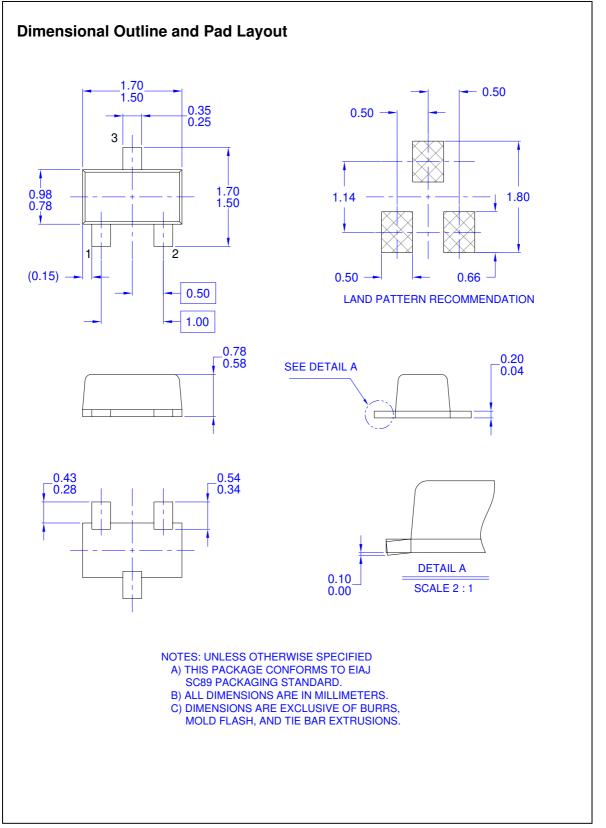
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